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Integrated Photonics Platforms III

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Contents

vii *Conference Committee*

SESSION 1 QUANTUM PHOTONICS

- 13012 02 **Integrated photonic cryptographic key generator using novel low-power MEMS-on-PIC technology** [13012-1]
- 13012 03 **Analysis of optical losses of GaAs waveguides for single-photon sources considering realistic waveguide roughness** [13012-3]
- 13012 04 **Optimization of edge couplers for low-loss photonic wire bonds on the thin film lithium niobate platform** [13012-73]

SESSION 2 INVERSE DESIGN/MODELLING

- 13012 05 **High-performance grating couplers for mid-infrared applications based on multiparameter optimization of geometry characteristics** [13012-6]
- 13012 06 **Periodic topology optimization-based inverse design of slow-light in silicon nitride one-dimensional grating waveguides** [13012-7]
- 13012 07 **Theoretical investigation of electric field induces second harmonic generation in silicon nitride waveguide structures** [13012-8]

SESSION 3 PHOTONIC INTEGRATED CIRCUITS

- 13012 08 **The open innovation photonics pilot line for northwest Europe (OIP4NWE) and its service offering** [13012-11]

SESSION 4 LIGHT MODULATION

- 13012 09 **Bi-junction electro-optic phase shifters** [13012-14]
- 13012 0A **Design and simulation of a graphene-on-silicon nitride electro-absorption dual-mode integrated waveguide modulator** [13012-15]
- 13012 0B **Towards scalable heterogeneous integration of thin-film lithium niobate on silicon photonics using microtransfer printing (Invited Paper)** [13012-13]

SESSION 5 ADVANCED PACKAGING

13012 0C **Scalable PIC packaging and polarization control in CPO (Invited Paper)** [13012-20]

SESSION 6 INTEGRATED LIGHT AMPLIFICATION AND EMISSION

13012 0D **Compact 1.31- μ m-emission In_{0.45}Ga_{0.55}As/ In_{0.25}Ga_{0.75}As photonic crystal nanoridge laser monolithically grown on 300 mm silicon substrate** [13012-22]

13012 0E **Data wavelength conversion over THz range using an optical-feedback-controlled InP multimode laser** [13012-23]

13012 0F **Ultracoherent emission by orthogonal lasers** [13012-24]

13012 0G **On-chip multiwavelength lasers enabling nanosecond scale wavelength switching times** [13012-25]

SESSION 7 PHOTONIC PLATFORMS

13012 0H **Thin-film lithium niobate PICs: advancements and potential applications in telecom and beyond (Invited Paper)** [13012-28]

SESSION 8 INTEGRATION AND ADVANCED FABRICATION AND DEVICES

13012 0I **Biasing impact on illuminated SiGe heterojunction phototransistor static performances** [13012-32]

13012 0J **Post-fabrication tuning of photonic integrated circuits via silicon ion implantation** [13012-33]

13012 0K **Process optimization for waveguide fabrication by liftoff processing in layers deposited by pulsed laser** [13012-35]

13012 0L **Monostatic FMCW LiDAR sensing in C-band using an integrated InP optical phased array** [13012-37]

13012 0M **Large, deterministic, and tunable thermo-optic shift for all photonic platforms** [13012-38]

POSTER SESSION

- 13012 0N **Comparative analysis of fabrication techniques for sensing windows on silicon nitride waveguide platforms** [13012-48]
- 13012 0O **Advancements in FDLW-fabricated Mach-Zehnder interferometers for the detection of physical parameters** [13012-49]
- 13012 0P **Photonics-assisted high-bandwidth, high spectral efficiency signal aggregation from low-bandwidth components and lower spectral efficient signals** [13012-50]
- 13012 0Q **Translation of optical device performance into e-beam lithography: a contribution to a better understanding** [13012-53]
- 13012 0R **Scalable photonic tensor cores with out-of-plane phase change memory cell switching** [13012-55]
- 13012 0S **Fabrication of high-Q multimode microring resonators on a photonic silicon-on-insulator platform** [13012-56]
- 13012 0T **Diamond integrated photonics for quantum computing applications** [13012-57]
- 13012 0U **Theoretical investigation of optical integration between quantum dot emission and silicon nitride waveguides** [13012-58]
- 13012 0W **CMOS-compatible electro-optical SRAM cavity device based on negative differential resistance** [13012-74]

DIGITAL POSTER SESSION

- 13012 0X **Enhancing reality: metalens array and color filter integration for immersive AR/VR** [13012-54]